ASSOCIATION CONNECTING LECTRONICS INDUSTRIES	PC. Bannockl	burn. Illinois. A	Il rights reserved untions.	under both	This docume level parts, t	ent is a declaration	ion of the spencompasse	ubstances s all lowe	within the ma	nufacturer l lls for whicl	isted item. Not h the manufacti	e: if the item is an arer has engineerin	assembly with lower g responsibility.	
	IPC Web Site for Information on IPC-1752 Standard Fo http://www.ipc.org/IPC-175x Di				Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Mater				s Materials	ials and Mfg Information				
Supplier Information														
Company name* Con		Company un	Company unique ID			Unique ID Authority					Response Date*			
nsemi											2024-05-03			
ontact Name Title - Contact			ct	F			Phone - Contact*				Email - Contact*			
Product-Env-Stewards Product Env			nviro Compliance			NA				Р	Product-Env-Stewards@onsemi.com			
Authorized Representative* Title - Representative			esentative			Phone - Representative*				E	Email - Representative*			
Product-Env-Stewards Product Enviro			iro Compliance			NA				P	Product-Env-Stewards@onsemi.com			
Requester Item Number	Mfr Item Number		per Mfr Item Name			Effective Date	Version	Manufacturing Site		Site	Weight*	UOM	Unit Type	
	NCP123	8BD65R2G	DSS AUTOR SOCP 65KHZ			2024-05-03		I	PH1		80.48	mg	Each	
Manufacturing Proccess Informa	tion													
Terminal Plating / Grid Array M	Array Material Terminal Base		Iloy J-STD-020 MSL Rating		Rating	Peak Pro	Peak Process Body Temperatu		are Max Time at Peak Tempera		mperature Nu	mber of Reflow C	ycles	
Matte Tin (Sn) - annealed CU Alloy		CU Alloy		1		260	260 C		30		seconds 3			
Comments														
evel 1 - maximum time at peak temperat	ire during so	ldering is 10-3	0 seconds											
or more information regarding material	composition	please refer to	page 3											

RoHS Material Composition Declaration				Declaration Type *	Detailed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Dibutyl phthalate (DBP), Dibutyl phthalate (DBP).										
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe v others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and co for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of						
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	on above	Supplier Acceptance	* Accepted							
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all						
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the						
Supplier Digital Signature Ra	stislav Drska	Le									

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	2.52	mg	Supplier	Silicon (Si)	7440-21-3		2.52	mg
Die Attach	0.43	mg	Supplier	Epoxized Condensate Of Para- Hydrobenzaldehyde And Alkyl Phenol	129915-35-1		0.086	mg
			Supplier	Silver (Ag)	7440-22-4		0.344	mg
Lead Frame	27.82	mg	Supplier	Silver (Ag)	7440-22-4		0.1669	mg
			Supplier	Zinc (Zn)	7440-66-6		0.0334	mg
			Supplier	Iron (Fe)	7439-89-6		0.6538	mg
			Supplier	Copper (Cu)	7440-50-8		26.9576	mg
			Supplier	Phosphorus (P)	7723-14-0		0.0083	mg
Mold Compound-Black	48.72	mg		Epoxy resin	proprietary data		2.436	mg
			Supplier	Phenolic Resin	Proprietary Data		2.436	mg
			Supplier	Ortho Cresol Novolac Resin	29690-82-2		0.9744	mg
			Supplier	Carbon Black (C)	1333-86-4		0.2436	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		42.63	mg
Plating	0.94	mg	Supplier	Tin (Sn)	7440-31-5		0.94	mg
Wire Bond - Cu	0.05	mg	Supplier	Copper (Cu)	7440-50-8		0.05	mg